



# 400W, 600W SURFACE MOUNT TRANSIENT VOLTAGE SUPPRESSOR

### **Features**

- 400, 600W Peak Pulse Power Dissipation
- 70V Standoff Voltage
- 100V Maximum Clamping Voltage
- Suitable for 48V Backplane Telecom Applications
- Glass Passivated Die Construction
- Fast Response Time: Typically Less than 1ps
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

# **Mechanical Data**

- Case: SMA / SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead-Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity Indicator: Cathode Band
- Weight: SMA 0.064 grams (Approximate)
  SMB 0.093 grams (Approximate)







Bottom View

# **Ordering Information (Note 4)**

Part Number	Case	Packaging
SMAT70A-13-F	SMA	5,000/Tape & Reel
SMBT70A-13-F	SMB	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

# **Marking Information**



xxx = Product Type Marking Code See Electrical Characteristics Table 11 = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year ex: 4 for 2014 WW = Week Code 01 to 53



# Maximum Ratings (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	SMAT70A	SMBT70A	Unit
Peak Pulse Power Dissipation	ь	400	600	W
(Non-repetitive current pulse derated above $T_A = +25$ °C)	P <sub>PK</sub>			VV
Peak Forward Surge Current, 8.3ms Single Half-Sine Wave	I	40	100	۸
Superimposed on Rated Load (Note 5)	IFSM	40	100	^
Instantaneous Forward Voltage @ I <sub>PP</sub> = 35A (Note 5)	$V_{F}$	3.5		V

# **Thermal Characteristics**

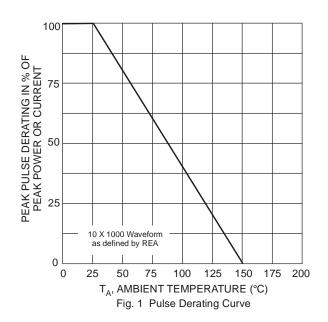
Characteristic	Symbol	Value	Unit
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

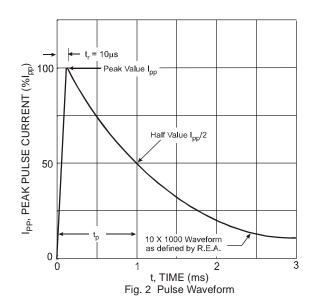
# Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

Part Number	Reverse Standoff Voltage	V <sub>BR</sub> (Not	age @ I <sub>T</sub> te 6)	Test Current	Max. Reverse Leakage @ V <sub>RWM</sub>	Max. Clamping Voltage @ I <sub>pp</sub>	Max. Peak Pulse Current I <sub>pp</sub>	Typical Total Capacitance (Note 6)	Typical Voltage Temp. Variation of V <sub>BR</sub>	Marking Code
	V <sub>RWM</sub> (V)	Min (V)	Max (V)	I <sub>T</sub> (mA)	I <sub>R</sub> (μA)	V <sub>C</sub> (V)	(A)	(pF)	mV/°C	
SMAT70A	70	77.8	89.5	1.0	5.0	100	3.5	140	80	KEX
SMBT70A	70	77.8	89.5	1.0	5.0	100	5.3	290	80	NPX

Notes: 5.  $V_{BR}$  measured with  $I_T$  current pulse = 10 ~ 15 ms.

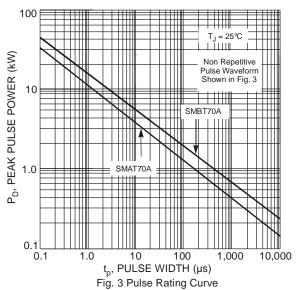
6. f = 1MHz,  $V_R = 0VDC$ .











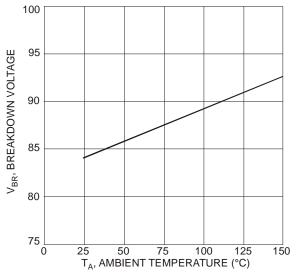
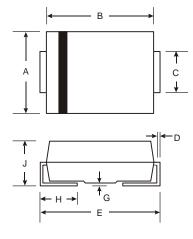


Fig. 4 Average Breakdown Voltage vs. Ambient Temperature

# **Package Outline Dimensions**

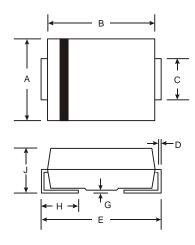
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.





SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
Е	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	2.01	2.30		
All Dimensions in mm				

### (2) SMB



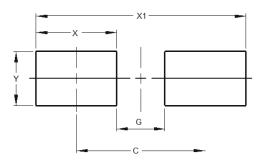
SMB			
Dim	Min	Max	
Α	3.30	3.94	
В	4.06	4.57	
С	1.96	2.21	
D	0.15	0.31	
Е	5.00	5.59	
<b>G</b> 0.05 0.20			
Н	0.76	1.52	
J	2.00	2.50	
All Dimensions in mm			



# **Suggested Pad Layout**

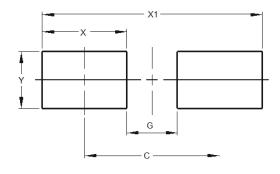
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### (1) SMA



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70

### (2) SMB



Dimensions	Value (in mm)
С	4.30
G	1.80
Х	2.50
X1	6.80
Υ	2.30



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